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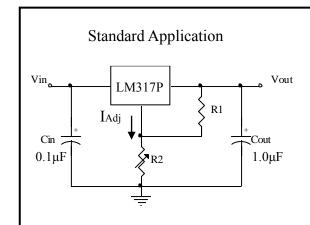
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# Three Terminal 1.5A Adjustable Output Positive Voltage Regulators

# LM317PJ3

The LM317PJ3 is an adjustable 3–terminal positive voltage regulator capable of supplying in excess of 1.5A over an output voltage range of 1.3 V to 37 V. This voltage regulator is exceptionally easy to use and requires only two external resistors to set the output voltage. Further, it employs internal current limiting, thermal shutdown and safe area compensation, making it essentially blow–out proof. The LM317PJ3 serves a wide variety of applications including local, on-card regulation. This device can also be used to make a programmable output regulator, or by connecting a fixed resistor between the adjustment and output, the LM317PJ3 can be used as a precision current regulator.

- Output current up to 1.5 A
- Output voltage adjustable between 1.3 V and 37 V
- Internal over temperature protection
- Internal short circuit protection
- Safe—area compensation for output transistor
- Pb-free lead plating and halogen-free package



- \*Cin is required if regulator is located an appreciate distance from power supply filter.
- \* \*Cout is not needed for stability, however, it does improve transient response.

$$V_{out}=1.25(1+R_2/R_1)+I_{Adj}R_2$$

Since  $I_{Adj}$  is controlled to less than 100  $\mu A$ , the error associated with this term is negligible in most applications.

### **Ordering Information**

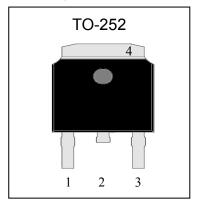
Device	Package	Shipping	
LM317PJ3-0-T3-G	TO-252 (Pb-free lead plating package)	2500 pcs / Tape & Reel	
	Environment friendly grade : S for RoHS compliant produgreen compound products	ects, G for RoHS compliant and	
	Packing spec, T3: 2500 pcs / tape & reel, 13" reel		
	Product rank, zero for no rank products		
	Product name		



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### **Package Information**



Pin	Function
1	ADJ
2	OUTPUT
3	INPUT
4	OUTPUT

### **Maximum Ratings** (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Input-Output Voltage Differential	V <sub>I</sub> -V <sub>O</sub>	40	V
Power Dissipation	PD	Internally Limited	W
Operating Junction Temperature Range	Topr	<b>-40</b> ∼ +125	$^{\circ}\!\mathbb{C}$
Storage Temperature Range	Tstg	<b>-</b> 65 ∼ +150	$^{\circ}\!\mathbb{C}$

### **Electrical Characteristics**

(T<sub>J</sub>=0 to 125°C, V<sub>I</sub>-V<sub>O</sub>=5V, I<sub>O</sub>=0.5A, I<sub>MAX</sub>=1.5A, P<sub>MAX</sub>=20W, unless otherwise noted)

Characteristics	Symbol	Conditions	Min	Тур	Max	Unit		
T: D 14: ( )	$\Delta V_{O(line)}$	Ta=25°C,3.0V≤VI-V	-	0.01	0.04	%/V		
Line Regulation(Note 1)		Ta=0~125°C,3.0V≤	-	0.02	0.07			
Load Regulation(Note 1)	$\Delta V_{O(load)}$	Ta=25°C	T <sub>A</sub> =25°C Vo≤6V		18	25	mV	
		10mA≤Io≤Imax	Vo≥5V	-	0.4	0.5	%/Vo	
		10mA≤Io≤Imax	Vo≤5V	-	40	70	mV	
		TUIIIA_IU_IMAX	Vo≥6V	-	0.8	1.5	%/Vo	
Adjust Pin Current	IAdj			-	46	100	μΑ	
Adjust Pin Current Change	$\Delta I$ Adj	2.5V\(\subseteq VI-VO\(\subseteq 40V\),10t PD\(\subseteq PMAX\)	-	0.2	5.0	μΑ		
Reference Voltage	Vref	3.0V\(\leq\)VI-VO\(\leq40\)V,101 PD\(\leq\)PMAX	1.2	1.25	1.3	V		
Temperature Stability	Ts	0≤TJ≤125°C	-	0.7	-	%/Vo		
Minimum Load Current to maintain Regulation	ILmin	V <sub>I</sub> -V <sub>O</sub> =40V	_	3.5	10	mA		
Maximum Output Current	Imax	VI-Vo≤15V,PD≤PMAX		1. 5	2.2	-	A	
_		VI-Vo≤15V,PD≤PMAX,TA=25°C		0.15	0.4	-		
RMS Noise vs % of Vout	eN	Ta=25°C,10Hz≤f≤10l	-	0.003	0.01	%/Vo		
Ripple Rejection(Note 2)	RR	Vo=10V,f=120Hz		-	60	-	αL	
	Vo=10V,f=120Hz, CAdj=10μF			66	75	-	dB	
Long-Term Stability(Note 3)	ST	Ta=25°C , 1000Hrs	-	0.3	1.0	%		
Junction to Case Thermal Resistance	RөJC	-	_	5	-	°C/W		



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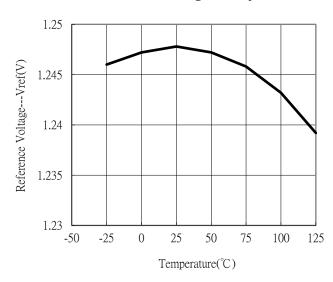
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Notes:1.Load and line regulation are specified at constant junction temperature. Changes in Vo due to heating effects must be taken into account separately. Pulse testing with low duty cycle is used.

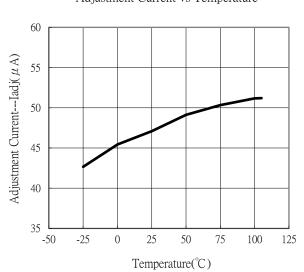
- 2.CAdj, when used, is connected between the adjustment pin and ground.
- 3. Since long-term stability cannot be measured on each device before shipment, this specification is an engineering estimate of average stability from lot to lot.
- 4.Power dissipation within an IC voltage regulator produces a temperature gradient on the die, affecting individual IC components on the die. These effects can be minimized by proper integrated circuit design and layout techniques. Thermal regulation is the effect of these temperature gradients on the output voltage and is expressed in percentage of output change per watt of power change in a specified time.

### **Typical Characteristics**

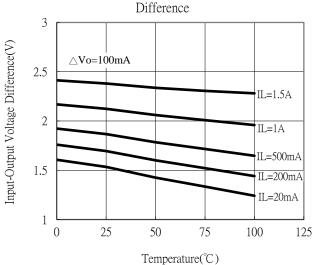
Reference Voltage vs Temperature







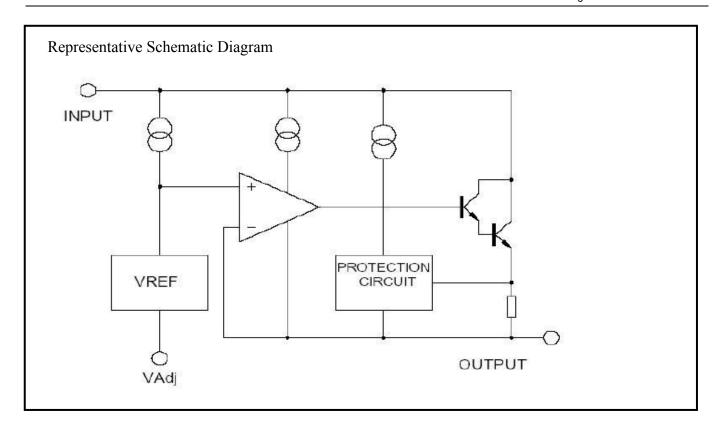
Dropout Voltage vs Input-Output Voltage

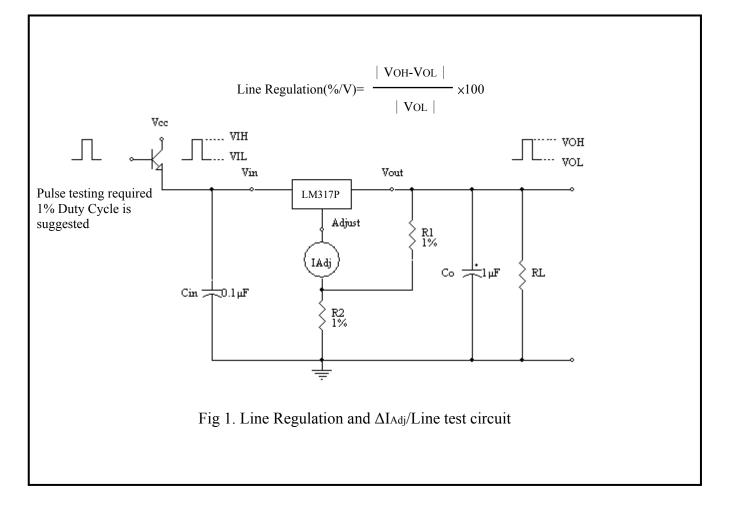




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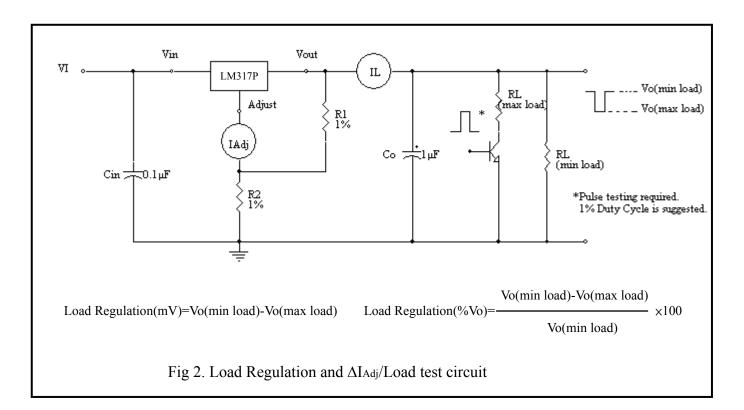


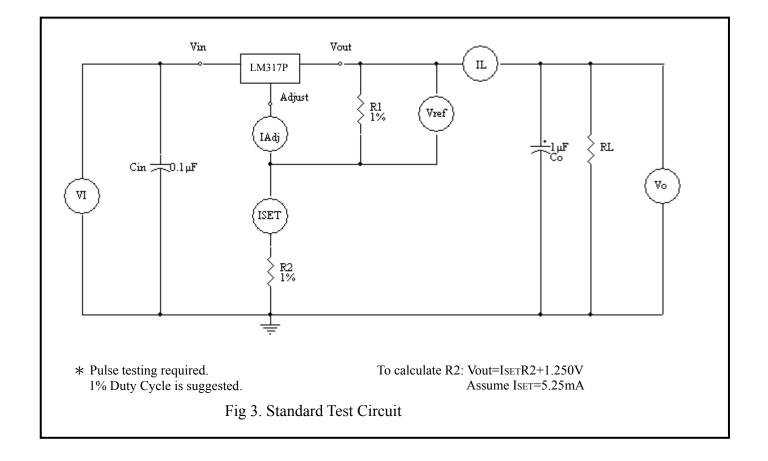




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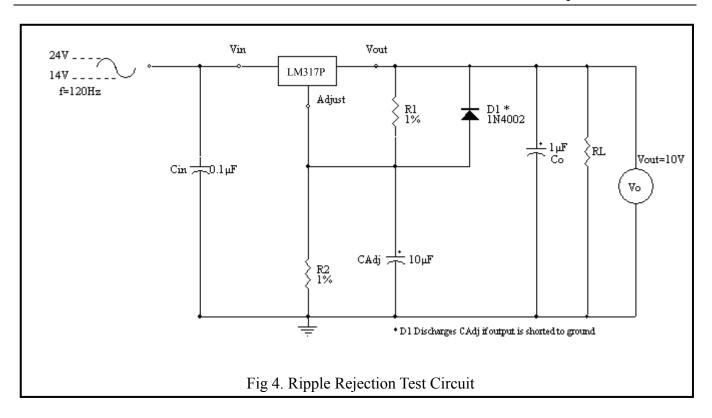






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### **Application Information**

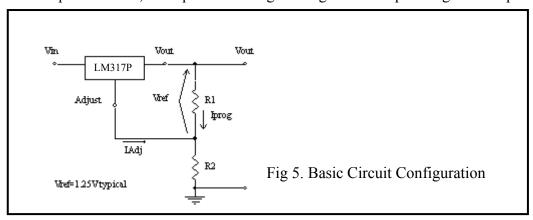
#### **Basic Circuit Operation**

The LM317P is a 3-terminal floating regulator. In operation, the LM317P develops and maintains a nominal 1.25V reference (Vref) between its output and adjustment terminals. This reference voltage is converted to a programming current (Iprog) by R1(see Fig 5), and this constant current flows through R2 to ground. The regulated output voltage is given by:

Vout=Vref
$$(1+R_2/R_1)+I_{Adj}R_2$$

Since the current from the adjustment terminal (IAdj) represents an error term in the equation, the LM317P was designed to control IAdj to less than 100  $\mu$ A and keep it constant. To do this, all quiescent operating current is returned to the output terminal. This imposes the requirement for a minimum load current. If the load current is less than this minimum, the output voltage will rise.

Since the LM317P is a floating regulator, it is only the voltage differential across the circuit which is important to performance, and operation at high voltages with respect to ground is possible.





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#### **Load Regulation**

The LM317P is capable of providing extremely good load regulation, but a few precautions are needed to obtain maximum performance. For best performance, the programming resistor (R1) should be connected as close to the regulator as possible to minimize line drops which effectively appear in series with the reference, thereby degrading regulation. The ground end of R2 can be returned near the load ground to provide remote ground sensing and improve load regulation.

#### **External Capacitors**

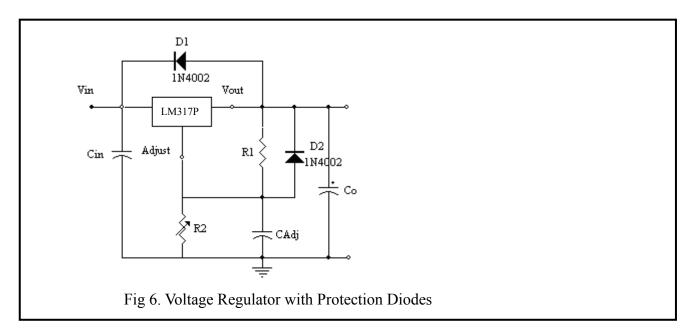
A  $0.1\mu F$  disc or  $1.0\mu F$  tantalum input bypass capacitor (Cin) is recommended to reduce the sensitivity to input line impedance.

The adjustment terminal may be bypassed to ground to improve ripple rejection. This capacitor ( $C_{Adj}$ ) prevents ripple from being amplified as the output voltage is increased. A  $10\mu F$  capacitor should improve ripple rejection about 15 dB at 120 Hz in a 10V application.

Although the LM317P is stable with no output capacitance, like any feedback circuit, certain values of external capacitance can cause excessive ringing. An output capacitance (Co) in the form of a  $1.0\mu F$  tantalum or  $25\mu F$  aluminum electrolytic capacitor on the output swamps this effect and insures stability.

#### **Protection Diodes**

When external capacitors are used with any IC regulator, it is sometimes necessary to add protection diodes to prevent the capacitors from discharging through low current points into the regulator. Fig 6 shows the LM317P with the recommended protection diodes for output voltages in excess of 25V or high capacitance values (Co>25 $\mu$ F,Cadj>10 $\mu$ F). Diode D1 prevents Co from discharging thru the IC during an input short circuit. Diode D2 protects against capacitor Cadj discharging through the IC during an output short circuit. The combination of diodes D1 and D2 prevents Cadj from discharging through the IC during an input short circuit.

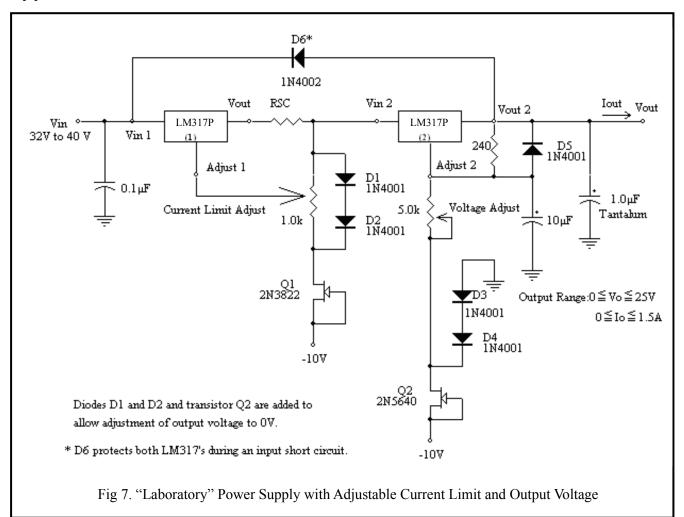


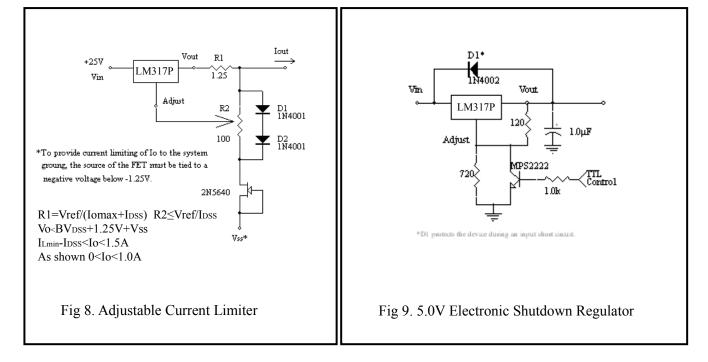


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### **Application Circuits**

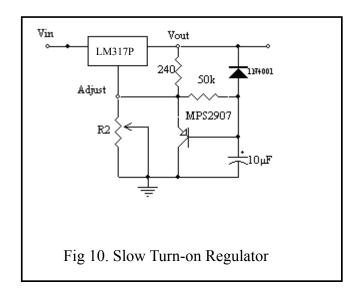


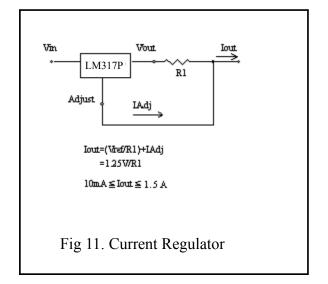




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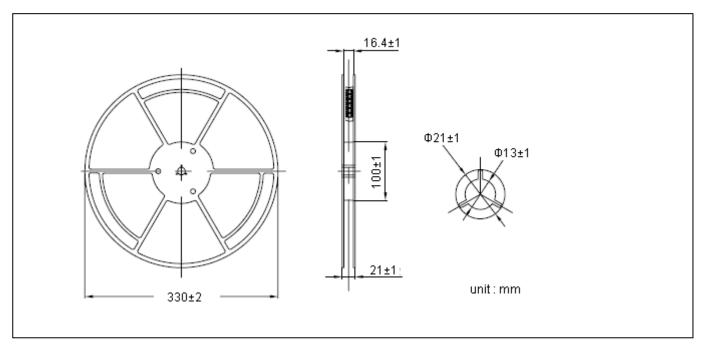




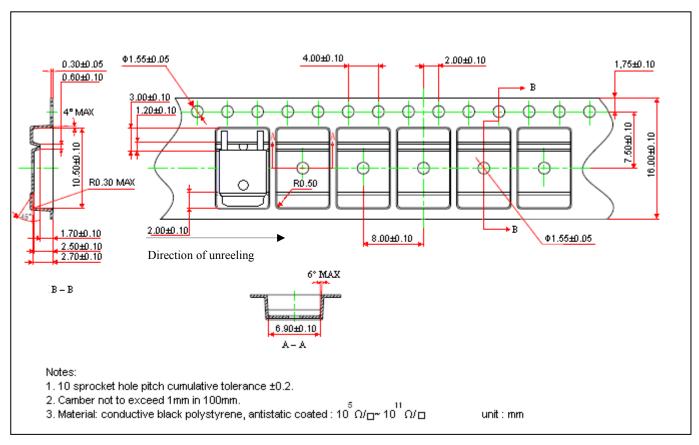
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### **Reel Dimension**



### **Carrier Tape Dimension**





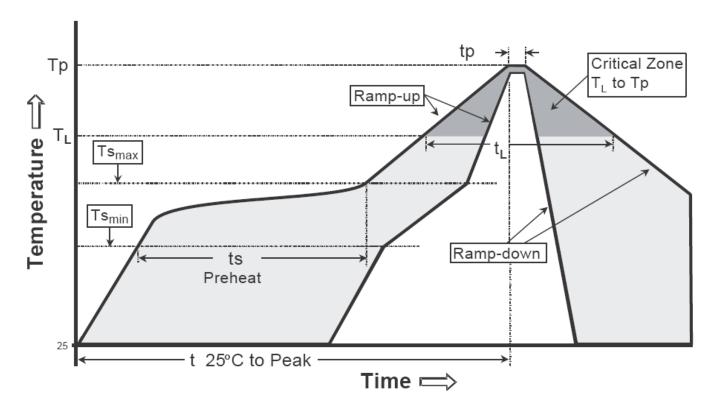
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Recommended wave soldering condition

Product	Peak Temperature	Soldering Time
Pb-free devices	260 +0/-5 °C	5 +1/-1 seconds

### Recommended temperature profile for IR reflow



Profile feature	Sn-Pb eutectic Assembly	Pb-free Assembly
Average ramp-up rate (Tsmax to Tp)	3°C/second max.	3°C/second max.
Preheat -Temperature Min(Ts min) -Temperature Max(Ts max) -Time(ts min to ts max)	100°C 150°C 60-120 seconds	150°C 200°C 60-180 seconds
Time maintained above:  -Temperature (TL)  - Time (tL)  Peak Temperature(TP)	183°C 60-150 seconds 240 +0/-5 °C	217°C 60-150 seconds 260 +0/-5 °C
Time within 5°C of actual peak temperature(tp)	10-30 seconds	20-40 seconds
Ramp down rate	6°C/second max.	6°C/second max.
Time 25 °C to peak temperature	6 minutes max.	8 minutes max.

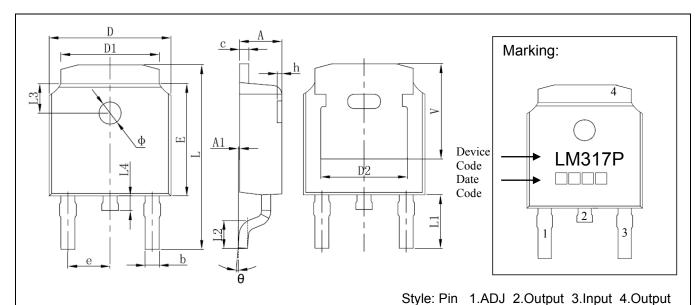
Note: All temperatures refer to topside of the package, measured on the package body surface.



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#### TO-252 Dimension



3-Lead TO-252 Plastic Surface Mount Package CYStek Package Code: J3

Date Code(counting from left to right):

1<sup>st</sup> code: year code, the last digit of Christian year

2<sup>nd</sup> code: month code, Jan→A, Feb→B, Mar→C,

Apr $\rightarrow$ D, May $\rightarrow$ E, Jun $\rightarrow$ F, Jul $\rightarrow$ G, Aug $\rightarrow$ H, Sep $\rightarrow$ J, Oct $\rightarrow$ K, Nov $\rightarrow$ L, Dec $\rightarrow$ M

3<sup>rd</sup> and 4<sup>th</sup> codes: production serial number, 01~99

DIM	Inc	hes	Millimeters		DIM	Inches		Millimeters	
	Min.	Max.	Min.	Max.	ווועו	Min.	Max.	Min.	Max.
Α	0.087	0.094	2.200	2.400	L	0.382	0.406	9.712	10.312
A1	0.000	0.005	0.000	0.127	L1	0.114 REF		2.900 REF	
b	0.025	0.030	0.635	0.770	L2	0.055	0.067	1.400	1.700
С	0.018	0.023	0.460	0.580	L3	0.063 REF		1.600 REF	
D	0.256	0.264	6.500	6.700	L4	0.024	0.039	0.600	1.000
D1	0.201	0.215	5.100	5.460	Φ	0.043	0.051	1.100	1.300
D2	0.190 REF		4.830 REF		θ	0°	8°	0°	8°
Е	0.236	0.244	6.000	6.200	h	0.000	0.012	0.000	0.300
е	0.086	0.094	2.186	2.386	V	0.207	REF	5.250	REF

Notes: 1. Controlling dimension: millimeters.

2.Maximum lead thickness includes lead finish thickness, and minimum lead thickness is the minimum thickness of base material. 3. If there is any question with packing specification or packing method, please contact your local CYStek sales office.

#### Material:

- Lead : Pure tin plated.
- Mold Compound: Epoxy resin family, flammability solid burning class: UL94V-0.

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